

概述/General Description

BG35F12M10S4 是一款由比亚迪半导体设计 开发的 miniPACK 封装的三相全桥模块。该产品具 有封装小、集成度高等优点;实现了三相变频电路 的高度集成,能够紧凑地设计主电路。模块集成温 度检测,可快速响应及温度实时输出。

BG35F12M10S4 is a cabinet and high integrated power module encapsulated by mini PACK that BYD has newly developed and designed. It highly combines convert circuit to make application circuit outside compact. It includes temperature detection function which can feedback quickly and output the analog temperature signal in real time.

产品特性/Features

- 1200V/35A, V_{CE sat}=2.1V@I_C=35A, 25°C
- 采用陶瓷覆铜板(DBC),低热阻设计 Very low thermal resistance due to using DBC
- BYD四代IGBT芯片技术,低导通和开关损耗 The 4th technology of BYD IGBT chip, low conduction and switching losses
- 饱和电压正温度系数
 Positive temperature coefficient
- 10µs短路耐受能力 Short Circuit withstand time-10µs

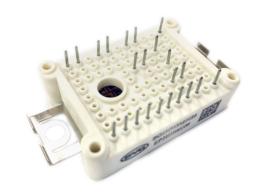
典型应用/Typical Applications

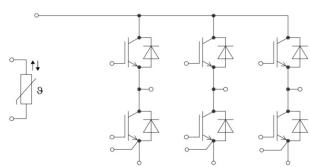
- 空调等变频家电
 Home appliances applications like air condition
- 变频、伺服控制器 Convert and servo controller
- 三相电机逆变器

 Three-phase inverter for ac motor

封装/Package

miniPACK1







IGBT,逆变器 / IGBT, Inverter

初步数据 Preliminary Data

最大额定值 / Maximum Rated Values

(T」=25°C,除非另外注明/unless otherwise noted)

参数	符号	符号工作条件			
Parameter	Symbol	Conditions	额定值 Ratings	单位 Units	
集电极-发射极电压 Collector-emitter voltage	V _{CES}	T _{vj} = 25°C	1200	V	
连续集电极直流电流 Continuous DC collector current	10 110111	$T_C = 100^{\circ}\text{C}, T_{vj} \text{ max} = 175^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}, T_{vj} \text{ max} = 175^{\circ}\text{C}$	35 70	А	
集电极重复峰值电流 Repetitive peak collector current	I _{CRM}	t _p = 1 ms	70	Α	
集电极功耗 Collector power dissipation	P _{tot}	T _C = 50°C,T _{vj max} = 175°C	208	W	
栅极-发射极电压 Gate-emitter voltage	V _{GES}		±20	V	

电气特性 / Electrical Characteristics

参数 Parameter	符号 Symbol	1	作条件 ditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Units
集电极-发射极饱和电压	_	V _{GE} =15V,I _C =3	1.7	2.1	2.3	V	
Collector-emitter saturation voltage	V _{CEsat}	V _{GE} =15V,I _C =3	35A, T _{vj} = 150°C	-	2.5	-	V
栅极-发射极阈值电压 Gate-emitter threshold voltage	V_{GEth}	I _C =1.6mA,V _{GI}	=V _{CE} ,T _{vj} = 25°C	5.0	5.8	7.0	V
栅极电荷 Gate charge	Q_G	V _{GE} = -15 V	+15 V		0.25		μC
内部栅极电阻 Internal gate resistor	R _{Gint}	T _{vj} = 25°C			12		Ω
输入电容 Input capacitance	Cies	f = 1 MHz, T _v V _{CE} = 25 V, V		2		nF	
反向传输电容 Reverse transfer capacitance	C _{res}	f = 1 MHz, T _{vj} = 25°C, V _{CE} = 25 V, V _{GE} = 0 V			0.08		nF
集电极-发射极截止电流 Collector-emitter cut-off current	I _{CES}	V _{CE} =1200V,V _{GE} =0V, T _{Vi} = 25°C		-	-	0.1	mA
栅极发射极漏电流 Gate leakage curren	I _{GES}	V _{CE} =0V,V _{GE} =	±20V, T _{vj} = 25°C	-	1	200	nA
开通延迟时间	-		T _{vj} =25°C	-	69.7	-	
Turn-on delay time	$T_{d \text{ on}}$.,	T _{vj} =150°C	-	81.6	-	
上升时间		V _{CC} =600V, I _C =35A,	T _{vj} =25°C	-	66	-	ns
Rise time	t _r	$V_{GE}=\pm 15V$, $R_{G}=12\Omega$	T _{vj} =150°C	-	58	-	
开通损耗	-	TNG-1212	T _{vj} =25°C	-	3.0	-	
Turn-on energy loss	Eon		T _{vj} =150°C	-	4.1	-	mJ



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关断延迟时间	T_{doff}	T _{vj} =25°C	-	157.1	-	
Turn-off delay time	I d off	T _{vj} =150°C	-	241.7	-	200
下降时间	4	T _{vj} =25°C	-	76.9	-	ns
Fall time	t _f	T _{vj} =150°C	-	129.3	-	
关断损耗	F	T _{vj} =25°C	-	1.9	-	
Turn-off energy loss	E _{off}	T _{vj} =150°C	-	3.52	-	mJ
短路耐受时间	1	V _{CC} = 800V, V _{CE} ≤ 1200V,	40	-	-	μs
Short-circuited withstand time	t _{sc}	V _{GE} ≤ 15V, Tj ≤ 150°C	10			
反偏安全工作区	DD004	$V_{CC} = 800V, V_{CE} \le 1200V,$				
Reverse biased safe operating area	RBSOA	V _{GE} = 20V, T _j ≤ 150°C	70	-	-	A
结一外壳热阻						
Thermal resistance, junction to case	R_{thJC}	每个 IGBT / per IGBT	-	0.6	-	K/W
外壳一散热器热阻		每个 IGBT / per IGBT				
Thermal resistance, case to	R_{thCH}	$\lambda_{Paste} = 1 \text{ W/(m • K)} / \lambda_{grease} =$	-	0.6	-	K/W
heatsink		1 W/(m•K)				
在开关状态下温度 Temperature under switching	T _{vj op}		-40	_	150	°C
conditions	. 1,00					

二极管,逆变器 / Diode, Inverter

最大额定值 / Maximum Rated Values

(T」=25°C,除非另外注明/unless otherwise noted)

参数	符号工作条件		额定值	单位
Parameter	Symbol	Conditions	Ratings	Units
反向重复峰值电压				
Repetitive peak reverse	V_{RRM}	V_{GE} =0V, I_{C} =25A	1200	V
voltage				
连续正向直流电流	l _F		35	Α
Continuous Forward current	11-		33	_ ^
正向重复峰值电流 Repetitive peak forward current	I _{FRM}	持续 1ms 的脉冲宽度 less than 1ms	70	А
I2t-值 I ² t - value	l² t	$V_R = 0 \text{ V}, t_P = 10 \text{ ms}, T_{vj} = 150^{\circ} \text{ C}$	244	A ² S



电气特性 / Electrical Characteristics

参数 Parameter	符号 Symbol	工作条件 Conditions		最小值 Min.	典型值 Typ.		单位 Units
正向压降	V_{F}	I _F =35A	T _{vj} =25°C	-	1.9	2.3	V
Forward voltage	VF	IF-33A	T _{vj} =150°C	-	1.87	-	V
反向恢复峰值电流		T _{vj} =25°C		-	14.7	-	Α
Peak reverse recovery current	I _{RM}	T _{vj} =150°C		-	18.1	-	Α
反向恢复电荷	Qr	T _{vj} =25°C		-	2.0	1	μC
Recovered charge	Qr	T _{vj} =150°C		-	5.08	-	μC
反向恢复损耗	F	T _{vj} =25°C		-	0.725	-	mJ
Reverse recovery energy	E _{rec}	T _{vj} =150°C		-	2.279	-	mJ
结一外壳热阻 Thermal resistance, junction to case	R _{thJC}	每个二极管 /	per diode	-	0.83	-	K/W
外壳一散热器热阻 Thermal resistance, case to heatsink	R _{thCH}	每个二极管 / per diode λ _{Paste} = 1 W/(m • K) / λ _{grease} = 1 W/(m • K)		-	0.80	-	K/W
在开关状态下温度 Temperature under switching conditions	T _{vj op}			-40	-	150	°C

负温度系数热敏电阻 / NTC-Thermistor

电气特性 / Electrical Characteristics

参数 Parameter	符号 Symbol	工作条件 Conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Units
额定电阻值 Rated resistance	R ₂₅	T _{vj} = 25°C	-	5	-	kΩ
R100 偏差 Deviation of R100	ΔR/R	$T_{vj} = 100^{\circ}C$, R100 = 465 Ω	-7.2	-	7.5	%
耗散功率 Power dissipation	P ₂₅	T _{vj} = 25°C	2	-	-	mW
B-值 B-value	B _{25/50}	$R_2 = R_{25} \text{ exp } [B_{25/50}(1/T2 - 1/(298,15 K))]$	-	3380	-	К

模块 / Module

参数 Parameter	符号 Symbol	工作条件 典型值 Conditions Typ.		单位 Units
绝缘耐压 Isolation test voltage	V _{ISOL}	RMS, f = 50 Hz, t = 1 min.	2.5	kV
内部绝缘介质 Internal isolation		基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)	Al ₂ O ₃	



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爬电距离	端 子 - 散 热 片 /Terminal to heatsink	11.5	mm
Creepage distance	端 子-端 子 /Terminal to terminal	6.3	mm
电气间隙	端 子 - 散 热 片 /Terminal to heatsink	10	mm
Clearance	端 子-端 子 /Terminal to terminal	5	mm

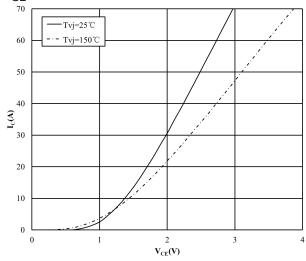
参数 Parameter	符号 Symbol	工作条件 Conditions		最小值 Min.	典型值 Typ.	最大值 Max.	单位 Units
杂散电感 Stray inductance	L _{sCE}			-	37	-	nΗ
模块引线电阻,端子-芯片		T _C = 25°C,	R _{CC'+EE'}	-	5.0	-	mΩ
Module lead resistance, terminals - chip	T _{jop}	每个开关 /per switch	R _{AA'+CC'}	-	6.0	-	mΩ
储存温度 Storage temperature	T _{stg}			-40	-	125	°C
模块的安装扭矩 Mounting torque for module mounting	M	M4 螺栓 Screw M4		2.0	-	3.5	N.m
重量 Weight	G			-	24	-	g



输出特性 IGBT,逆变器(典型) output characteristic IGBT, Inverter (typical)

$$I_C = f(V_{CE})$$

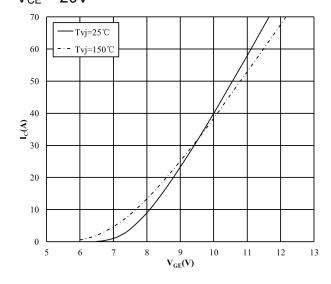




传输特性 IGBT, 逆变器(典型) transfer characteristic IGBT, Inverter (typical)

$$I_C = f(V_{GE})$$

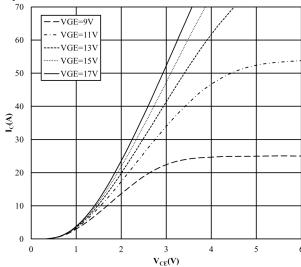
 $V_{CE} = 20V$



输出特性 IGBT,逆变器(典型) output characteristic IGBT, Inverter (typical)

$$I_C = f(V_{CE})$$

$$T_{vj} = 150^{\circ}C$$

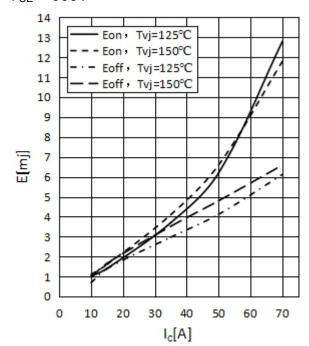


开关损耗 IGBT, 逆变器(典型) switching losses IGBT, Inverter (typical)

$$E_{on} = f(I_C), E_{off} = f(I_C)$$

$$V_{\text{GE}} = \pm \, 15 \text{V}, \, R_{\text{Gon}} = \, 12 \Omega, \, R_{\text{Goff}} = \, 12 \Omega, \,$$

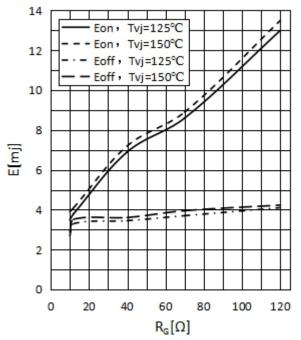
$$V_{CF} = 600V$$





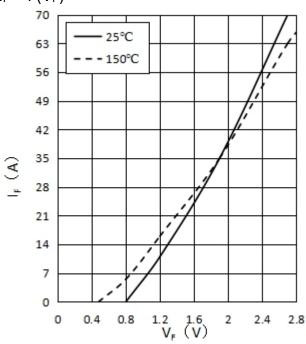
开关损耗 IGBT, 逆变器(典型) switching losses IGBT, Inverter (typical) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$

 $V_{GE} = \pm 15 \text{ V}, I_{C} = 35 \text{A}, V_{CE} = 600 \text{V}$



正向偏压特性 二极管,逆变器(典型) forward characteristic of Diode, Inverter (typical)

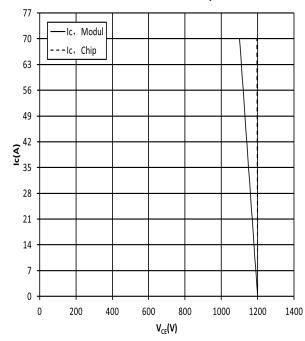
$$I_F = f(V_F)$$



反偏安全工作区 IGBT, 逆变器(RBSOA) reverse bias safe operating area IGBT, Inverter (RBSOA)

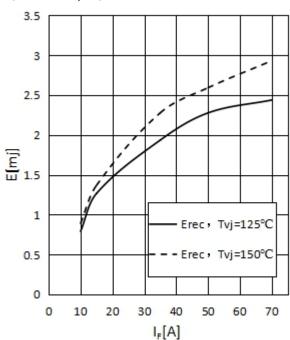
 $I_C = f(V_{CE})$

 $V_{GE} = \pm 15 \text{ V}, R_{Goff} = 12\Omega, T_{vj} = 150^{\circ}\text{C}$



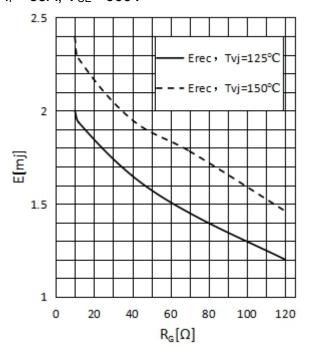
开关损耗 二极管,逆变器 (典型) switching losses Diode, Inverter (typical) E_{rec} = f (I_F)

 $R_{Gon} = 12\Omega$, $V_{CE} = 600V$

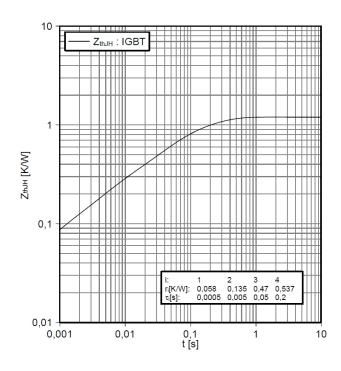




开关损耗 二极管,逆变器(典型) switching losses Diode, Inverter (typical) $E_{rec} = f(R_G)$ $I_F = 35A, V_{CE} = 600V$

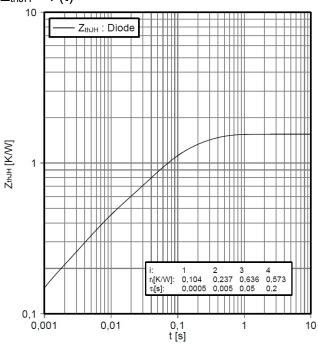


瞬态热阻抗 IGBT, 逆变器 transient thermal impedance IGBT,Inverter $Z_{\text{thJH}} = f(t)$

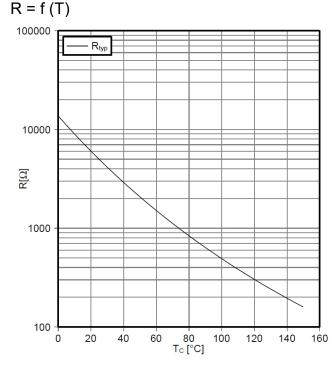


瞬态热阻抗 二极管,逆变器 transient thermal impedance Diode, Inverter



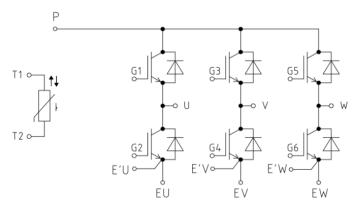


负温度系数热敏电阻 温度特性 NTC-Thermistor-temperature characteristic (typical)

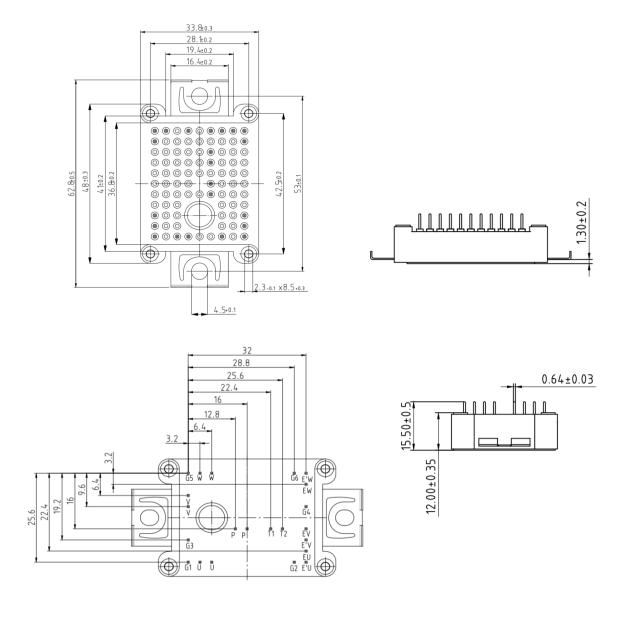




接线图 / circuit_diagram_headline



封装尺寸 / package outlines





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